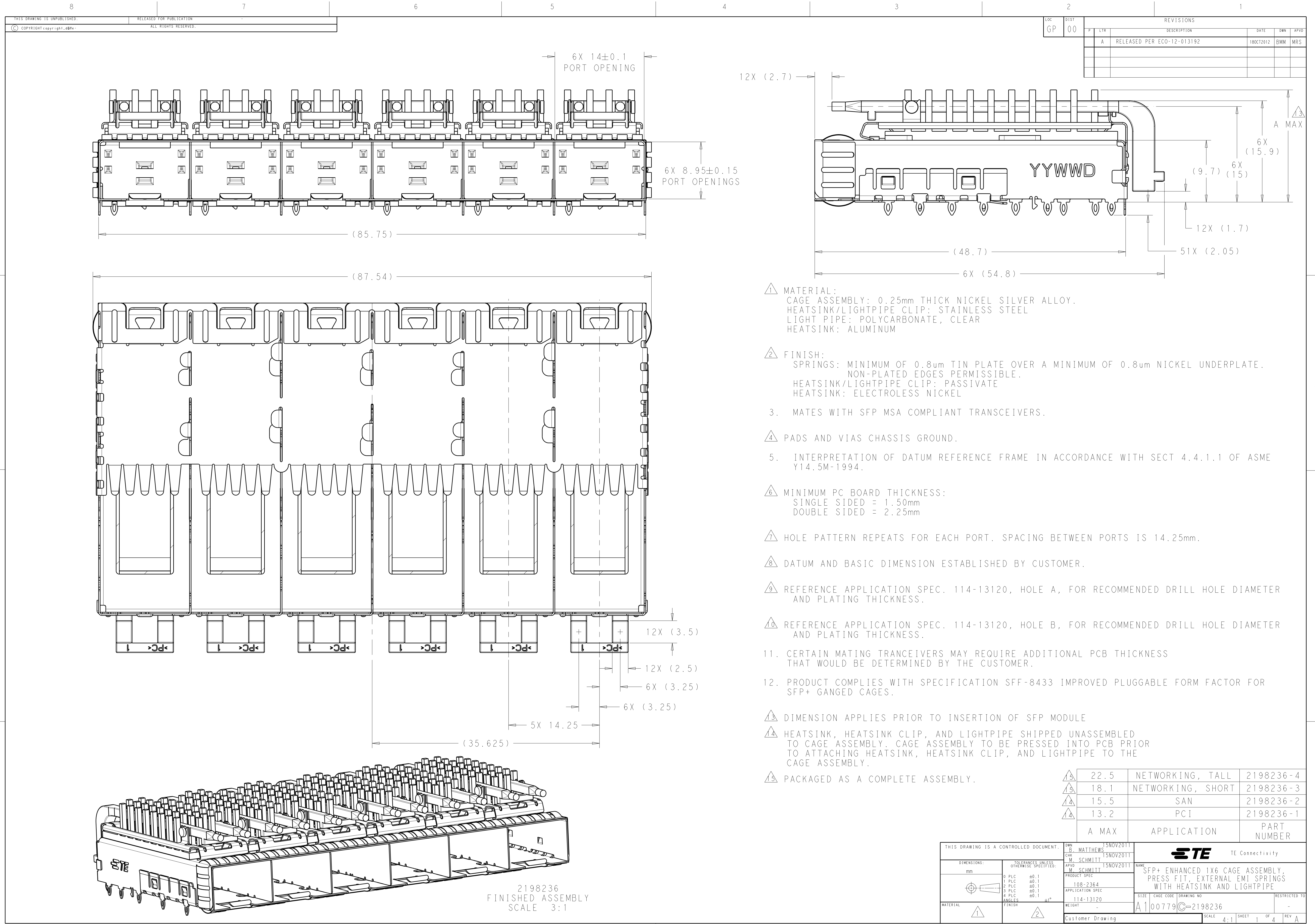




LOC		DIST		REVISIONS					
GP		00		P	LTR	DESCRIPTION	DATE	DWN	APVD
					A	RELEASED PER ECO-12-013192	18OCT2012	BMM	MRS

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6X 14±0.1
PORT OPENING

6X 8.95±0.15
PORT OPENINGS

(85.75)

(87.54)

12X (2.7)

YYWWD

6X (15.9)

6X (15)

(9.7)

12X (1.7)

51X (2.05)

(48.7)

6X (54.8)

1 MATERIAL:
CAGE ASSEMBLY: 0.25mm THICK NICKEL SILVER ALLOY.
HEATSINK/LIGHTPIPE CLIP: STAINLESS STEEL
LIGHT PIPE: POLYCARBONATE, CLEAR
HEATSINK: ALUMINUM

2 FINISH:
SPRINGS: MINIMUM OF 0.8um TIN PLATE OVER A MINIMUM OF 0.8um NICKEL UNDERPLATE.
NON-PLATED EDGES PERMISSIBLE.
HEATSINK/LIGHTPIPE CLIP: PASSIVATE
HEATSINK: ELECTROLESS NICKEL

3. MATES WITH SFP MSA COMPLIANT TRANSCEIVERS.

4 PADS AND VIAS CHASSIS GROUND.

5. INTERPRETATION OF DATUM REFERENCE FRAME IN ACCORDANCE WITH SECT 4.4.1.1 OF ASME Y14.5M-1994.

6 MINIMUM PC BOARD THICKNESS:
SINGLE SIDED = 1.50mm
DOUBLE SIDED = 2.25mm

7 HOLE PATTERN REPEATS FOR EACH PORT. SPACING BETWEEN PORTS IS 14.25mm.

8 DATUM AND BASIC DIMENSION ESTABLISHED BY CUSTOMER.

9 REFERENCE APPLICATION SPEC. 114-13120, HOLE A, FOR RECOMMENDED DRILL HOLE DIAMETER AND PLATING THICKNESS.

10 REFERENCE APPLICATION SPEC. 114-13120, HOLE B, FOR RECOMMENDED DRILL HOLE DIAMETER AND PLATING THICKNESS.

11. CERTAIN MATING TRANSCEIVERS MAY REQUIRE ADDITIONAL PCB THICKNESS THAT WOULD BE DETERMINED BY THE CUSTOMER.

12. PRODUCT COMPLIES WITH SPECIFICATION SFF-8433 IMPROVED PLUGGABLE FORM FACTOR FOR SFP+ GANGED CAGES.

13 DIMENSION APPLIES PRIOR TO INSERTION OF SFP MODULE

14 HEATSINK, HEATSINK CLIP, AND LIGHTPIPE SHIPPED UNASSEMBLED TO CAGE ASSEMBLY. CAGE ASSEMBLY TO BE PRESSED INTO PCB PRIOR TO ATTACHING HEATSINK, HEATSINK CLIP, AND LIGHTPIPE TO THE CAGE ASSEMBLY.

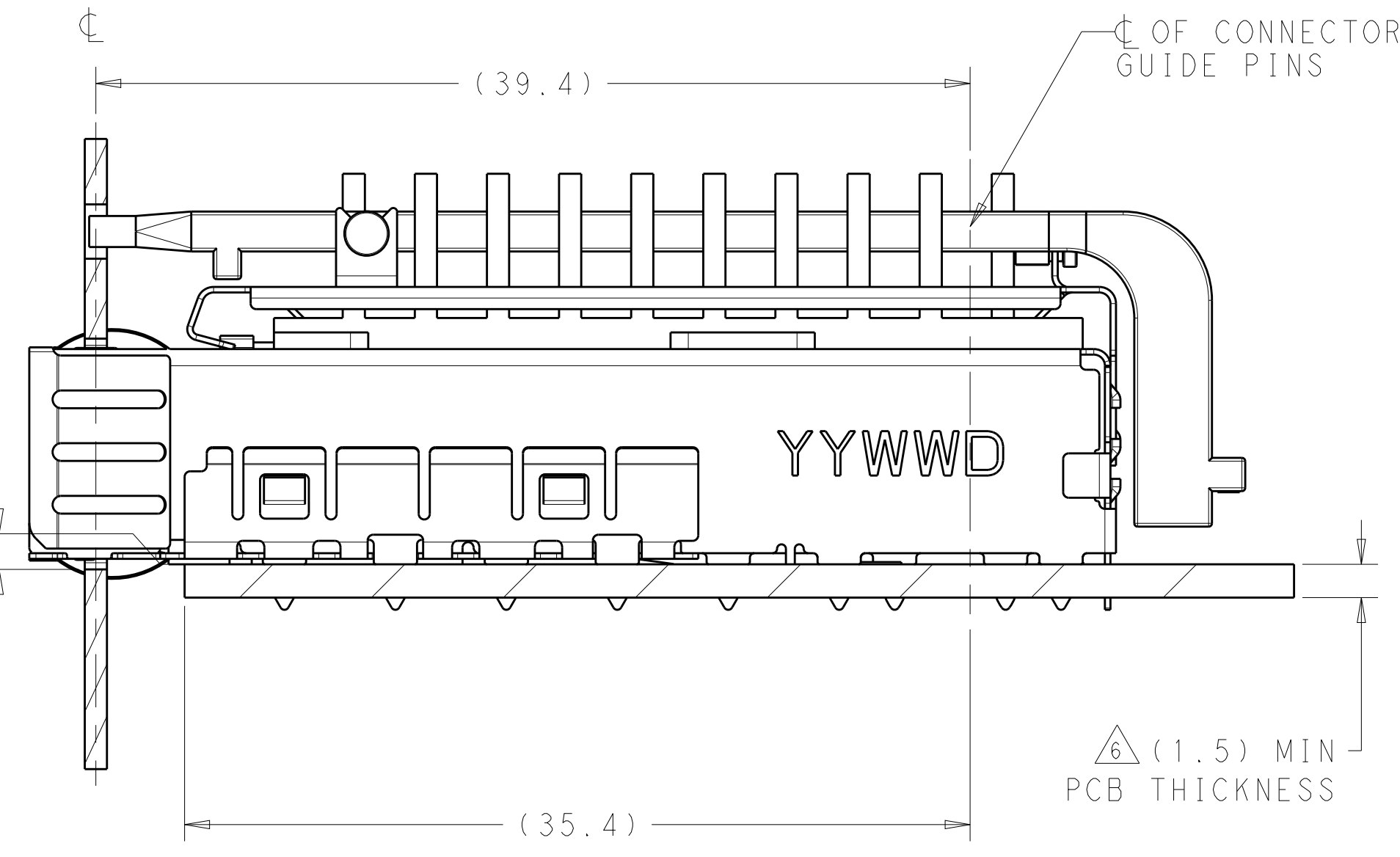
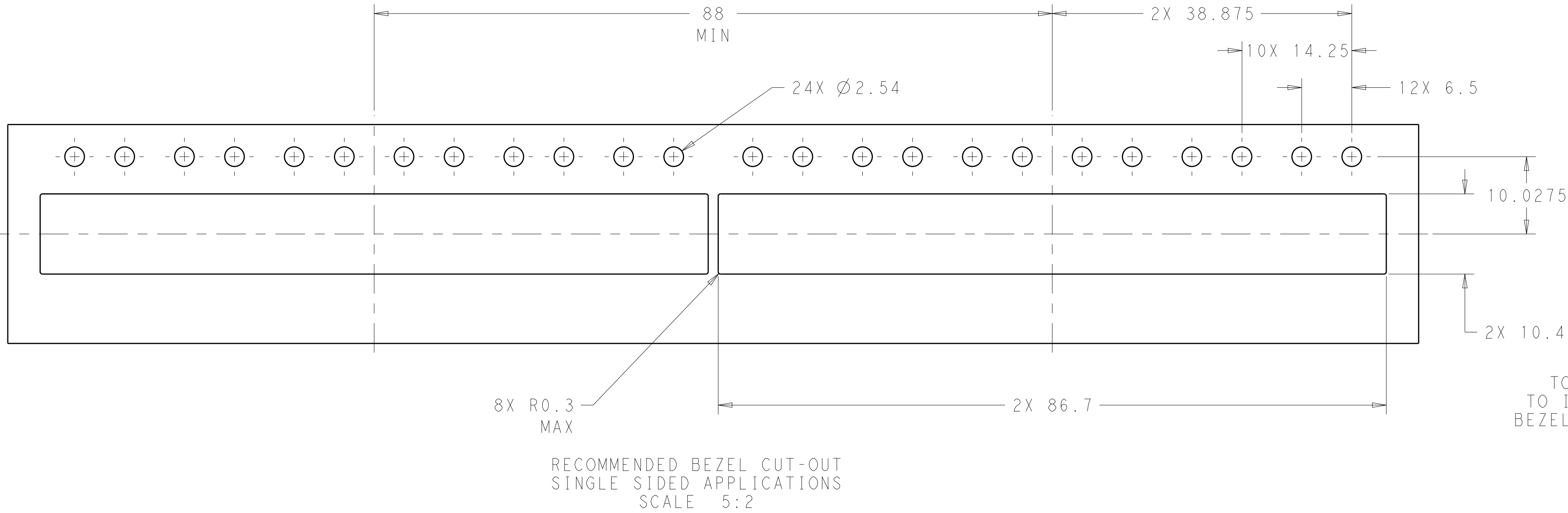
15 PACKAGED AS A COMPLETE ASSEMBLY.

22.5	NETWORKING, TALL	2198236-4
18.1	NETWORKING, SHORT	2198236-3
15.5	SAN	2198236-2
13.2	PCI	2198236-1
A MAX	APPLICATION	PART NUMBER

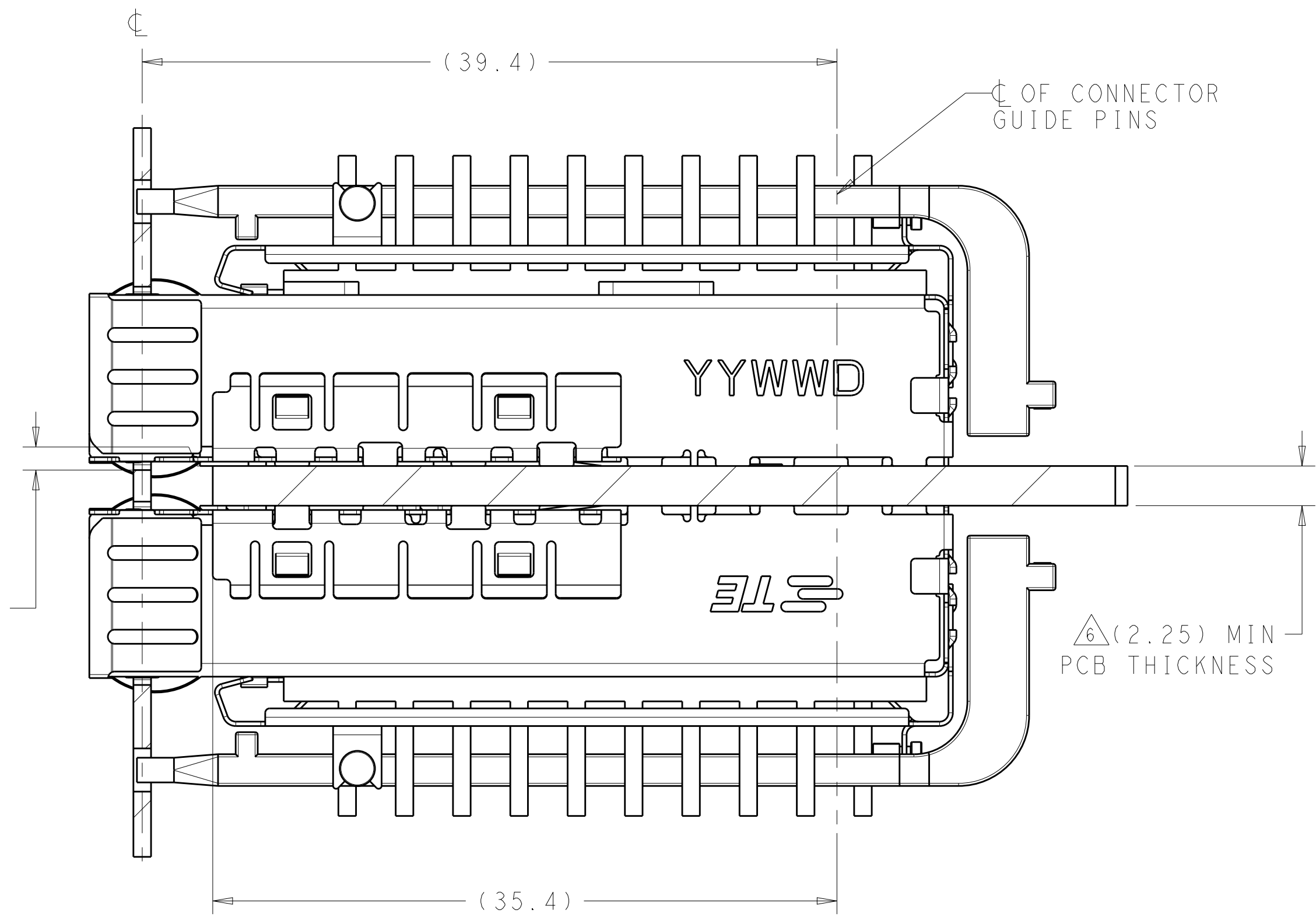
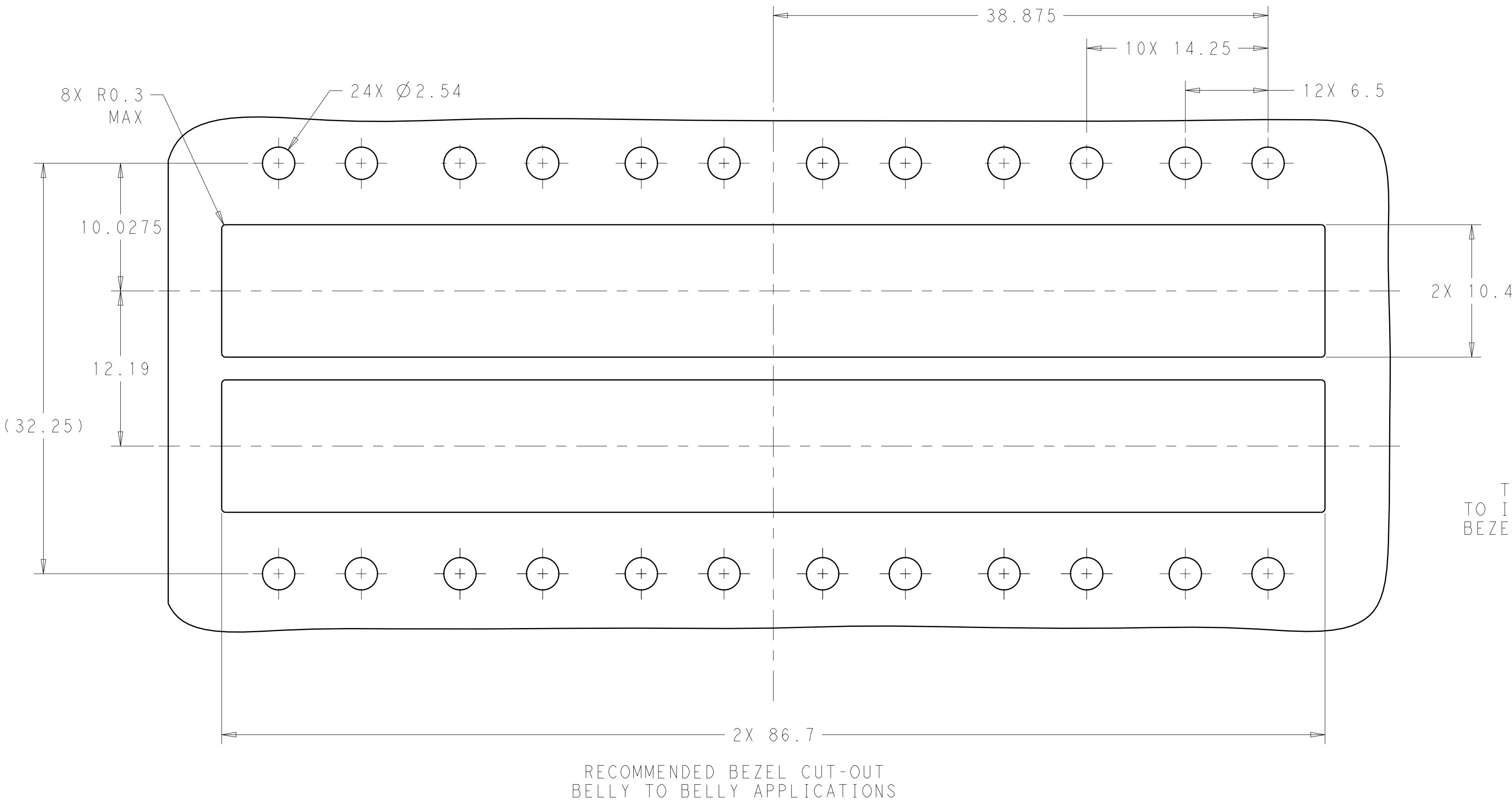
THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN	B. MATTHEWS	15NOV2011
DIMENSIONS:		CHK	M. SCHMITT	15NOV2011
mm		APVD	M. SCHMITT	15NOV2011
TOLERANCES UNLESS OTHERWISE SPECIFIED:		PRODUCT SPEC		
0 PLC		108-2364		
1 PLC		APPLICATION SPEC		
2 PLC		114-13120		
3 PLC		WEIGHT		
4 PLC		Customer Drawing		
ANGLES		SCALE		
FINISH		4:1		

NAME		SFP+ ENHANCED 1X6 CAGE ASSEMBLY, PRESS FIT, EXTERNAL EMI SPRINGS WITH HEATSINK AND LIGHTPIPE	
SIZE		CAGE CODE	
DRAWING NO		RESTRICTED TO	
A100779		C=2198236	
SHEET		REV	
1		A	

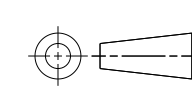
2198236
FINISHED ASSEMBLY
SCALE 3:1

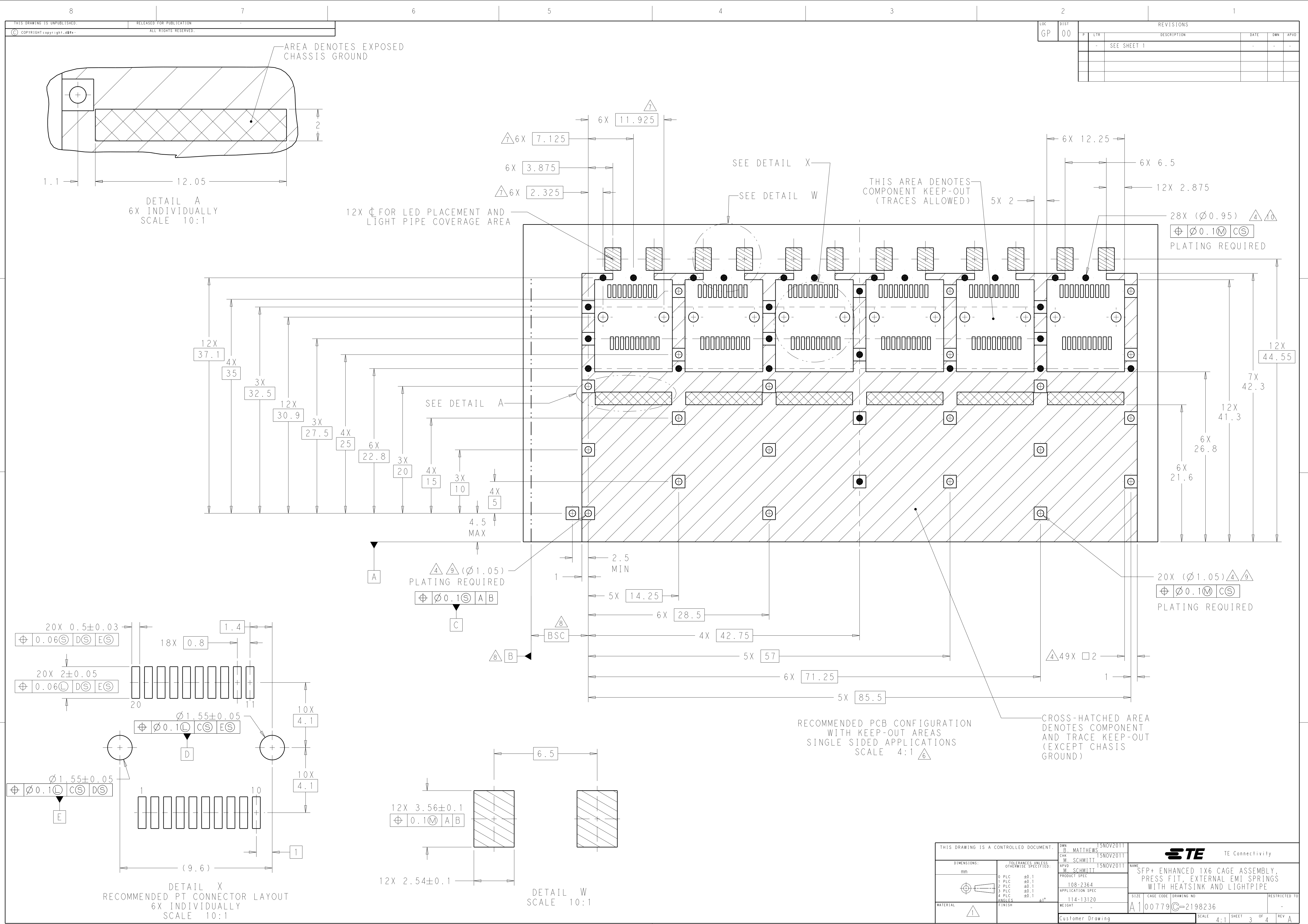


2198236
MOUNTED ON PC BOARD
SHOWN THRU RECOMMENDED BEZEL

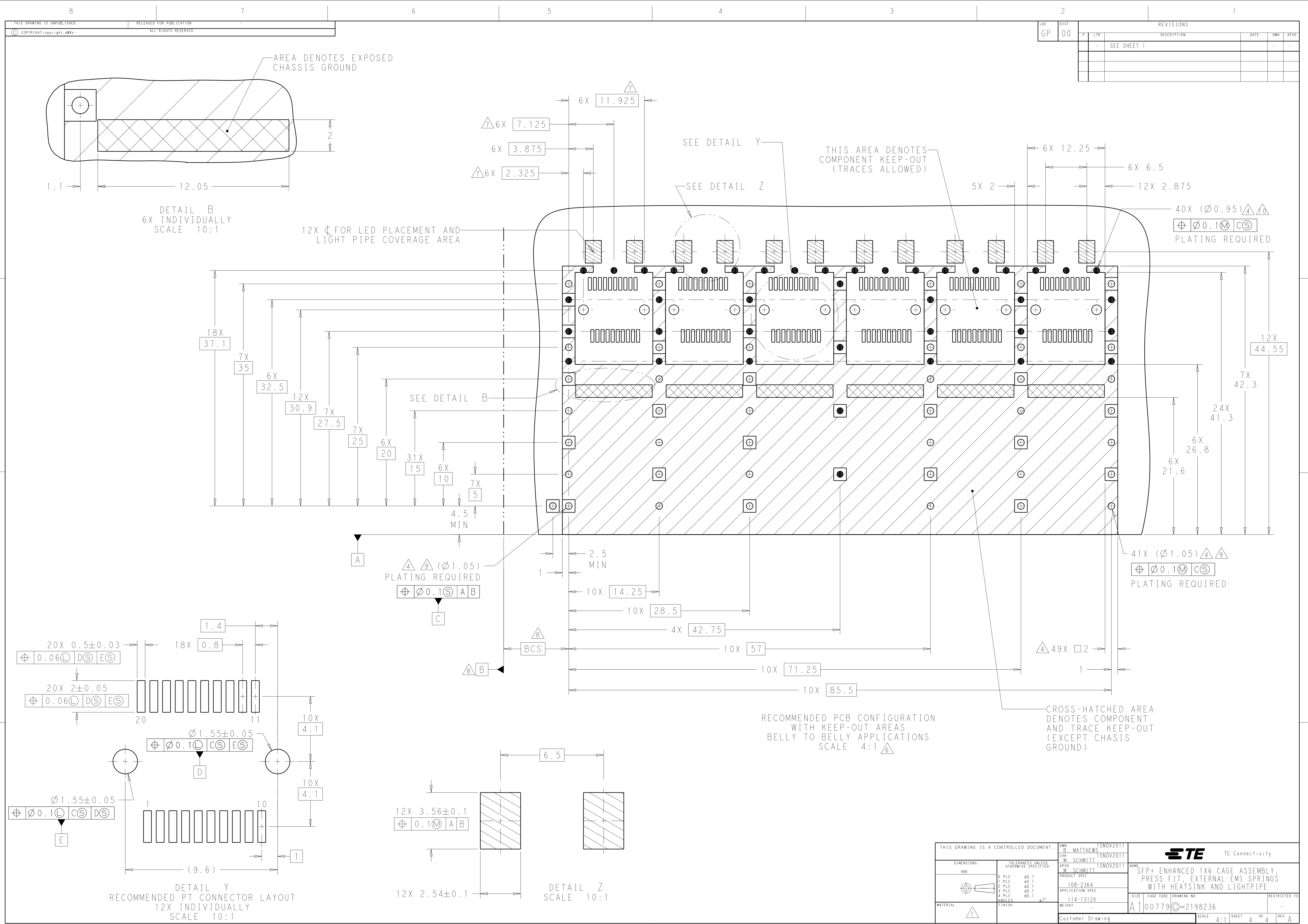


2198236
MOUNTED BELLY TO BELLY ON PC BOARD
SHOWN THRU RECOMMENDED BEZEL

THIS DRAWING IS A CONTROLLED DOCUMENT.		OWN B. MATTHEWS 15NOV2011	 TE Connectivity	
DIMENSIONS:		CHK M. SCHMITT 15NOV2011		
mm	TOLERANCES UNLESS OTHERWISE SPECIFIED:	APVD M. SCHMITT 15NOV2011	NAME SFP+ ENHANCED 1X6 CAGE ASSEMBLY, PRESS FIT, EXTERNAL EMI SPRINGS WITH HEATSINK AND LIGHTPIPE	
	0 PLC ±0.1 1 PLC ±0.1 2 PLC ±0.1 3 PLC ±0.1 4 PLC ±0.1 ANGLES ±1° FINISH	PRODUCT SPEC 108-2364 APPLICATION SPEC 114-13120	SIZE A1	
MATERIAL		WEIGHT -	CAGE CODE 00779	
		Customer Drawing	DRAWING NO 2198236	
		SCALE 4:1	SHEET 2 OF 4	
		REV A		



LOC		DIST		REVISONS			
GP		00		DATE	OWN	APVD	
				SEE SHEET 1			



LOC		DIST		REVISONS			
GP		00		DATE	OWN	APVD	
				SEE SHEET 1	-	-	-

THIS DRAWING IS A CONTROLLED DOCUMENT.		OWN B. MATTHEWS	15NOV2011	 TE Connectivity	
		CHK M. SCHMITT	15NOV2011		
DIMENSIONS:		APVD M. SCHMITT	15NOV2011	NAME SFP+ ENHANCED 1X6 CAGE ASSEMBLY, PRESS FIT, EXTERNAL EMI SPRINGS WITH HEATSINK AND LIGHTPIPE	
mm		TOLERANCES UNLESS OTHERWISE SPECIFIED:		PRODUCT SPEC 108-2364	
		0 PLC ±0.1		APPLICATION SPEC	
		1 PLC ±0.1		114-13120	
		2 PLC ±0.1		WEIGHT	
		3 PLC ±0.1		Customer Drawing	
		4 PLC ±0.1		SCALE 4:1	
		ANGLES ±1°		SHEET 4 OF 4	
MATERIAL		FINISH		REV A	

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

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Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

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